

DATA SHEET

PSMN005-55B; PSMN005-55P
N-channel logic level
TrenchMOS^(TM) transistor

Product specification

October 1999

SiliconMAX

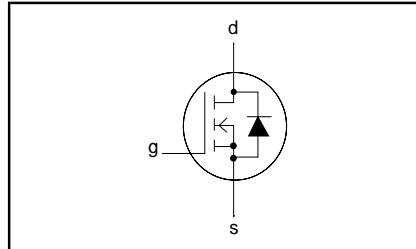
N-channel logic level TrenchMOS^(TM) transistor

**PSMN005-55B;
PSMN005-55P**

FEATURES

- 'Trench' technology
- Very low on-state resistance
- Fast switching
- Low thermal resistance

SYMBOL



QUICK REFERENCE DATA

| |
|---|
| $V_{DSS} = 55\text{ V}$ |
| $I_D = 75\text{ A}$ |
| $R_{DS(ON)} \leq 5.8\text{ m}\Omega (V_{GS} = 10\text{ V})$ |
| $R_{DS(ON)} \leq 6.3\text{ m}\Omega (V_{GS} = 5\text{ V})$ |

GENERAL DESCRIPTION

SiliconMAX products use the latest Philips Trench technology to achieve the lowest possible on-state resistance in each package at each voltage rating.

Applications:-

- d.c. to d.c. converters
- switched mode power supplies

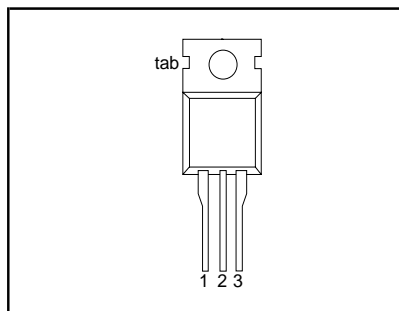
The PSMN005-55P is supplied in the SOT78 (TO220AB) conventional leaded package.

The PSMN005-55B is supplied in the SOT404 surface mounting package.

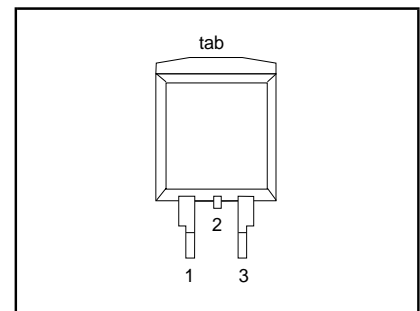
PINNING

| PIN | DESCRIPTION |
|-----|--------------------|
| 1 | gate |
| 2 | drain ¹ |
| 3 | source |
| tab | drain |

SOT78 (TO220AB)



SOT404 (D²PAK)



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|----------------|--|---|------|----------|------------------|
| V_{DSS} | Drain-source voltage | $T_j = 25\text{ }^\circ\text{C}$ to $175\text{ }^\circ\text{C}$ | - | 55 | V |
| V_{DGR} | Drain-gate voltage | $T_j = 25\text{ }^\circ\text{C}$ to $175\text{ }^\circ\text{C}$; $R_{GS} = 20\text{ k}\Omega$ | - | 55 | V |
| V_{GS} | Continuous gate-source voltage | | - | ± 15 | V |
| V_{GSM} | Peak pulsed gate-source voltage | $T_j \leq 150\text{ }^\circ\text{C}$ | - | ± 20 | V |
| I_D | Continuous drain current | $T_{mb} = 25\text{ }^\circ\text{C}$; $V_{GS} = 5\text{ V}$ $T_{mb} = 100\text{ }^\circ\text{C}$; $V_{GS} = 5\text{ V}$ | - | 75^2 | A |
| I_{DM} | Pulsed drain current | $T_{mb} = 25\text{ }^\circ\text{C}$ | - | 240 | A |
| P_D | Total power dissipation | $T_{mb} = 25\text{ }^\circ\text{C}$ | - | 230 | W |
| T_j, T_{stg} | Operating junction and storage temperature | | - 55 | 175 | $^\circ\text{C}$ |

¹ It is not possible to make connection to pin:2 of the SOT404 package

² maximum current limited by package

Silicon MAXN-channel logic level TrenchMOS^(TM) transistorPSMN005-55B;
PSMN005-55P**THERMAL RESISTANCES**

| SYMBOL | PARAMETER | CONDITIONS | TYP. | MAX. | UNIT |
|----------------|--|--|----------|--------|------------|
| $R_{th\ j-mb}$ | Thermal resistance junction to mounting base | | - | 0.65 | K/W |
| $R_{th\ j-a}$ | Thermal resistance junction to ambient | SOT78 package, in free air SOT404 package, pcb mounted, minimum footprint | 60 50 | - - | K/W K/W |

AVALANCHE ENERGY LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|----------|----------------------------------|---|------|------|------|
| E_{AS} | Non-repetitive avalanche energy | Unclamped inductive load, $I_{AS} = 75\text{ A}$; $t_p = 100\ \mu\text{s}$; T_j prior to avalanche = 25°C ; $V_{DD} \leq 15\text{ V}$; $R_{GS} = 50\ \Omega$; $V_{GS} = 5\text{ V}$ | - | 268 | mJ |
| I_{AS} | Non-repetitive avalanche current | | - | 75 | A |

ELECTRICAL CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------|----------------------------------|---|------------------|-----------------|---------------------------|--|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage | $V_{GS} = 0\text{ V}$; $I_D = 0.25\text{ mA}$; $T_j = -55^\circ\text{C}$ | 55 50 | - - | - - | V V |
| $V_{GS(TO)}$ | Gate threshold voltage | $V_{DS} = V_{GS}$; $I_D = 1\text{ mA}$; $T_j = 175^\circ\text{C}$ $T_j = -55^\circ\text{C}$ | 1.0 0.5 | 1.5 - | 2.0 - | V V V |
| $R_{DS(ON)}$ | Drain-source on-state resistance | $V_{GS} = 10\text{ V}$; $I_D = 25\text{ A}$ $V_{GS} = 5\text{ V}$; $I_D = 25\text{ A}$ $V_{GS} = 4.5\text{ V}$; $I_D = 25\text{ A}$ $V_{GS} = 5\text{ V}$; $I_D = 25\text{ A}$; $T_j = 175^\circ\text{C}$ | - - - - | 4.8 5.3 - | 5.8 6.3 6.7 13.2 | m Ω m Ω m Ω m Ω |
| I_{GSS} | Gate source leakage current | $V_{GS} = \pm 10\text{ V}$; $V_{DS} = 0\text{ V}$ | - | 2 | 100 | nA |
| I_{DSS} | Zero gate voltage drain current | $V_{DS} = 55\text{ V}$; $V_{GS} = 0\text{ V}$; $T_j = 175^\circ\text{C}$ | - | 0.05 | 10 500 | μA μA |
| $Q_{g(tot)}$ | Total gate charge | $I_D = 75\text{ A}$; $V_{DD} = 44\text{ V}$; $V_{GS} = 5\text{ V}$ | - | 103 | - | nC |
| Q_{gs} | Gate-source charge | | - | 15 | - | nC |
| Q_{gd} | Gate-drain (Miller) charge | | - | 52 | - | nC |
| $t_{d\ on}$ | Turn-on delay time | $V_{DD} = 30\text{ V}$; $R_D = 1.2\ \Omega$; | - | 45 | - | ns |
| t_r | Turn-on rise time | $V_{GS} = 5\text{ V}$; $R_G = 10\ \Omega$ | - | 180 | - | ns |
| $t_{d\ off}$ | Turn-off delay time | Resistive load | - | 420 | - | ns |
| t_f | Turn-off fall time | | - | 235 | - | ns |
| L_d | Internal drain inductance | Measured from tab to centre of die | - | 3.5 | - | nH |
| L_d | Internal drain inductance | Measured from drain lead to centre of die (SOT78 package only) | - | 4.5 | - | nH |
| L_s | Internal source inductance | Measured from source lead to source bond pad | - | 7.5 | - | nH |
| C_{iss} | Input capacitance | $V_{GS} = 0\text{ V}$; $V_{DS} = 25\text{ V}$; $f = 1\text{ MHz}$ | - | 6500 | - | pF |
| C_{oss} | Output capacitance | | - | 1500 | - | pF |
| C_{riss} | Feedback capacitance | | - | 700 | - | pF |

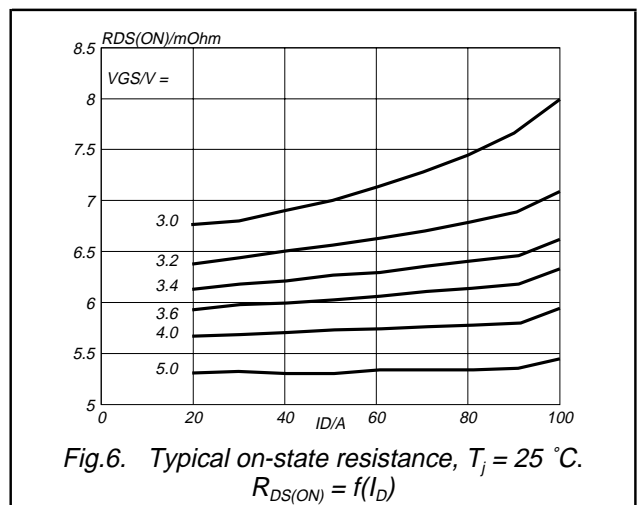
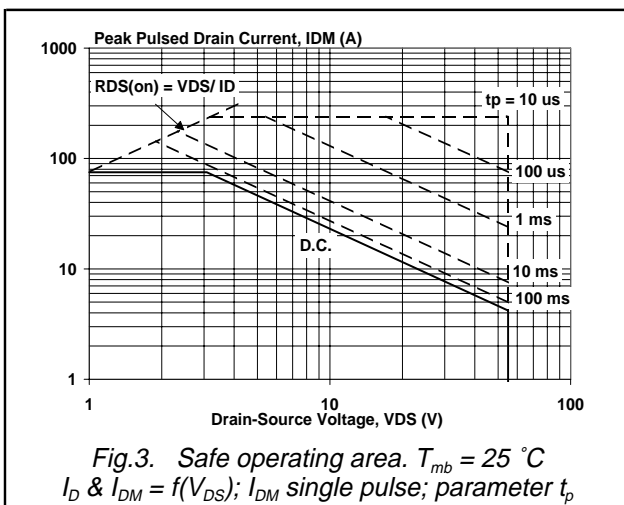
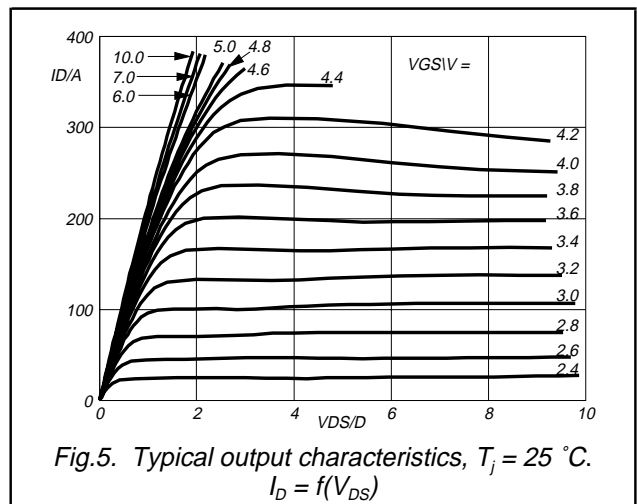
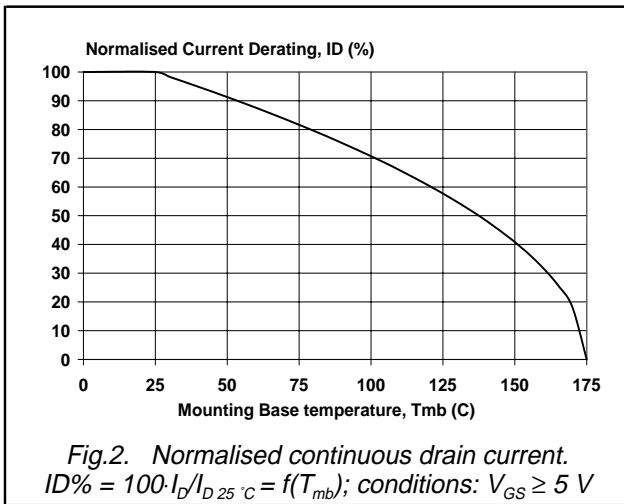
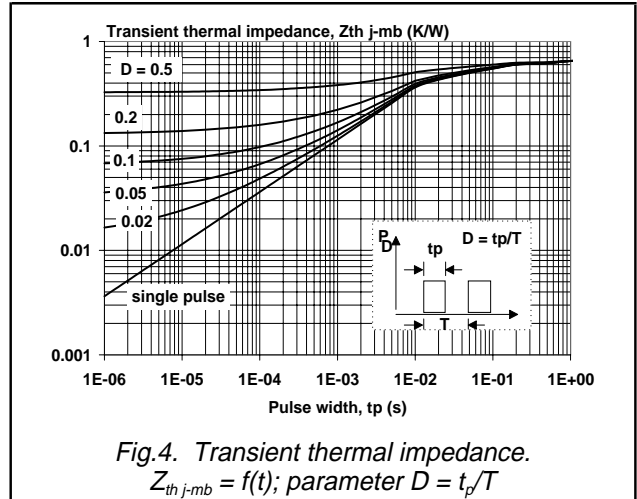
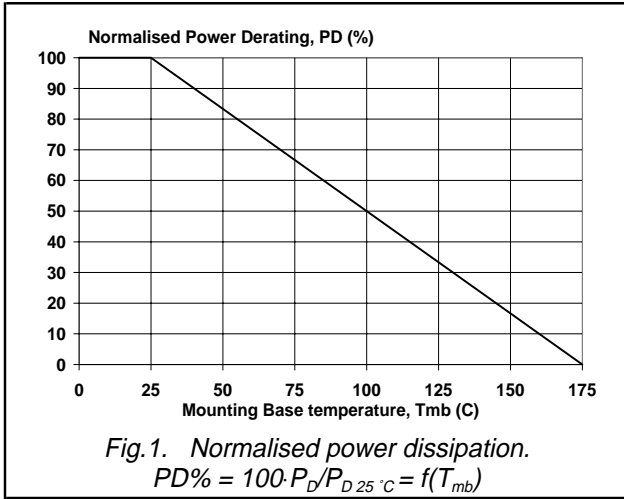
Silicon MAXN-channel logic level TrenchMOS^(TM) transistorPSMN005-55B;
PSMN005-55P**REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS** $T_j = 25^\circ\text{C}$ unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------|--|---|------|------|------|---------------|
| I_S | Continuous source current (body diode) | | - | - | 75 | A |
| I_{SM} | Pulsed source current (body diode) | | - | - | 240 | A |
| V_{SD} | Diode forward voltage | $I_F = 25\text{ A}; V_{GS} = 0\text{ V}$ | - | 0.85 | 1.2 | V |
| | | $I_F = 75\text{ A}; V_{GS} = 0\text{ V}$ | - | 1.1 | - | V |
| t_{rr} | Reverse recovery time | $I_F = 20\text{ A}; -di_F/dt = 100\text{ A}/\mu\text{s};$ $V_{GS} = 0\text{ V}; V_R = 30\text{ V}$ | - | 80 | - | ns |
| Q_{rr} | Reverse recovery charge | | - | 0.2 | - | μC |

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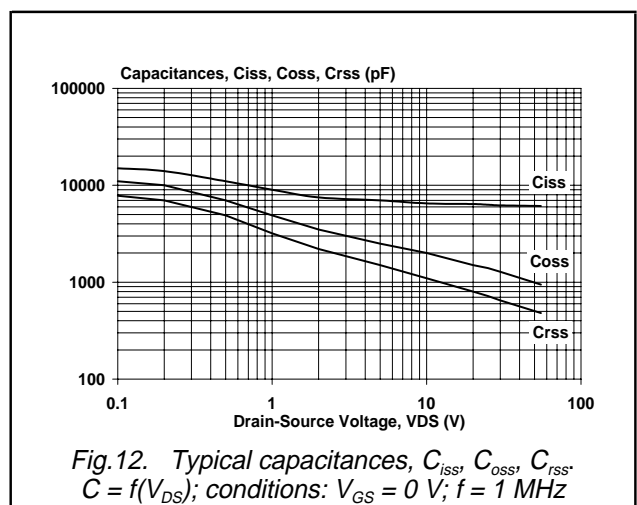
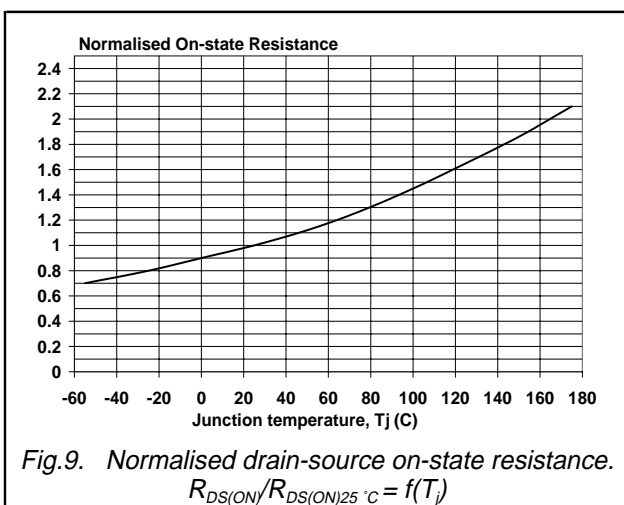
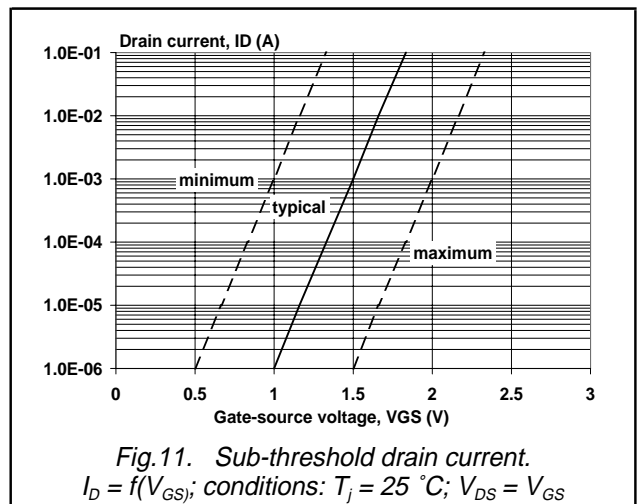
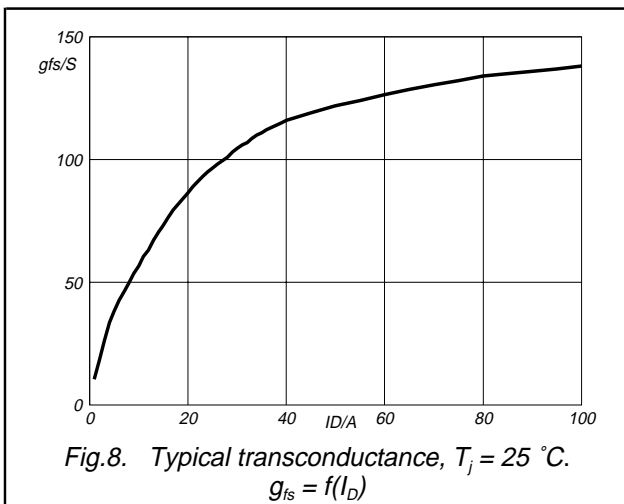
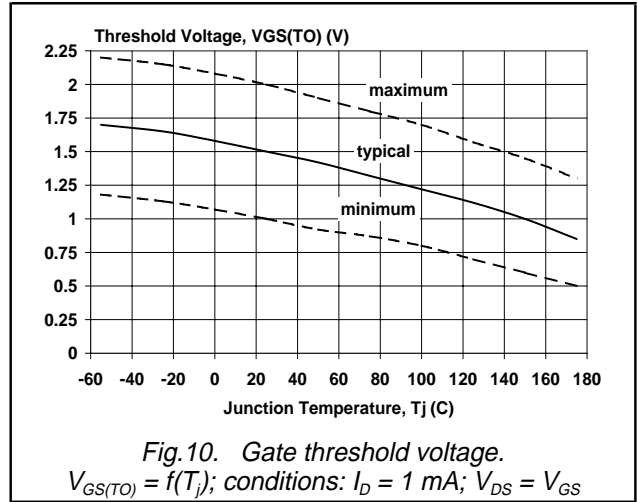
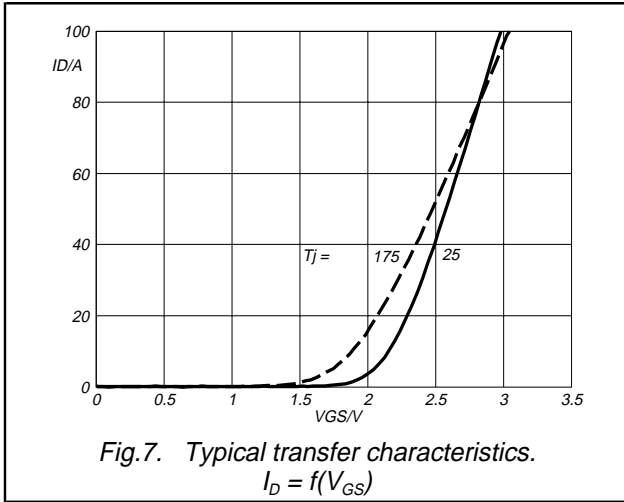
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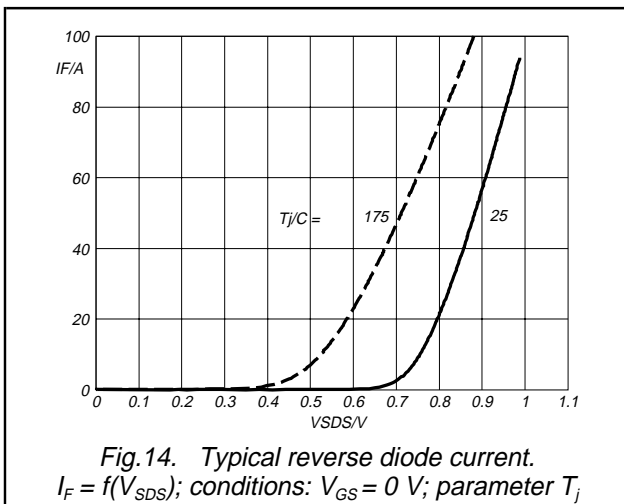
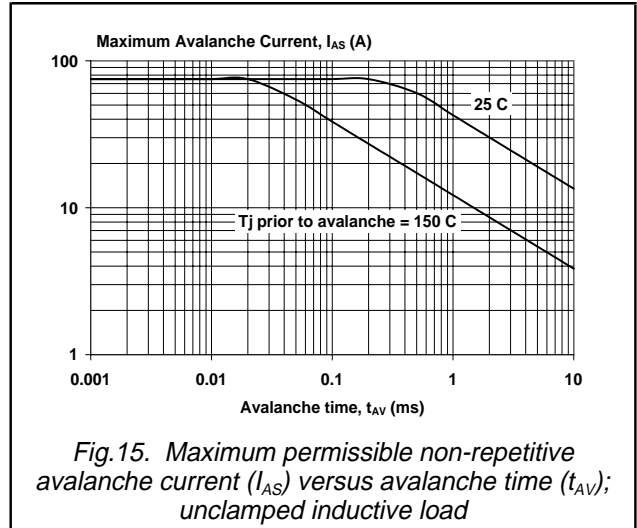
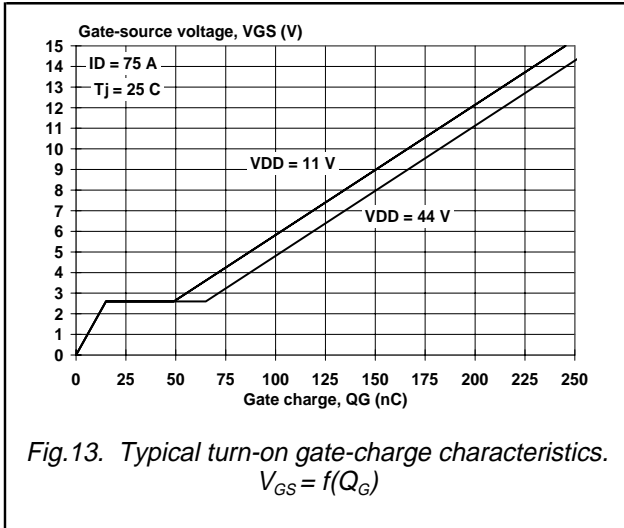
PSMN005-55B;
PSMN005-55P



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PSMN005-55P





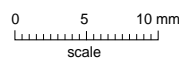
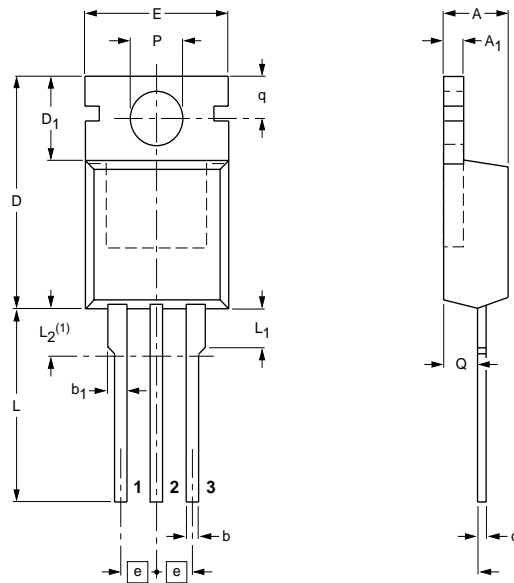
N-channel logic level TrenchMOS^(TM) transistor

PSMN005-55B;
PSMN005-55P

MECHANICAL DATA

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220

SOT78



DIMENSIONS (mm are the original dimensions)

| UNIT | A | A ₁ | b | b ₁ | c | D | D ₁ | E | e | L | L ₁ | L ₂ ⁽¹⁾ max. | P | q | Q |
|------|------------|----------------|------------|----------------|------------|--------------|----------------|-------------|------|--------------|----------------|---------------------------------------|------------|------------|------------|
| mm | 4.5 4.1 | 1.39 1.27 | 0.9 0.7 | 1.3 1.0 | 0.7 0.4 | 15.8 15.2 | 6.4 5.9 | 10.3 9.7 | 2.54 | 15.0 13.5 | 3.30 2.79 | 3.0 | 3.8 3.6 | 3.0 2.7 | 2.6 2.2 |

Note

1. Terminals in this zone are not tinned.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|--------|------|--|---------------------|------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT78 | | TO-220 | | | | 97-06-11 |

Fig.16. SOT78 (TO220AB); pin 2 connected to mounting base (Net mass:2g)

Notes

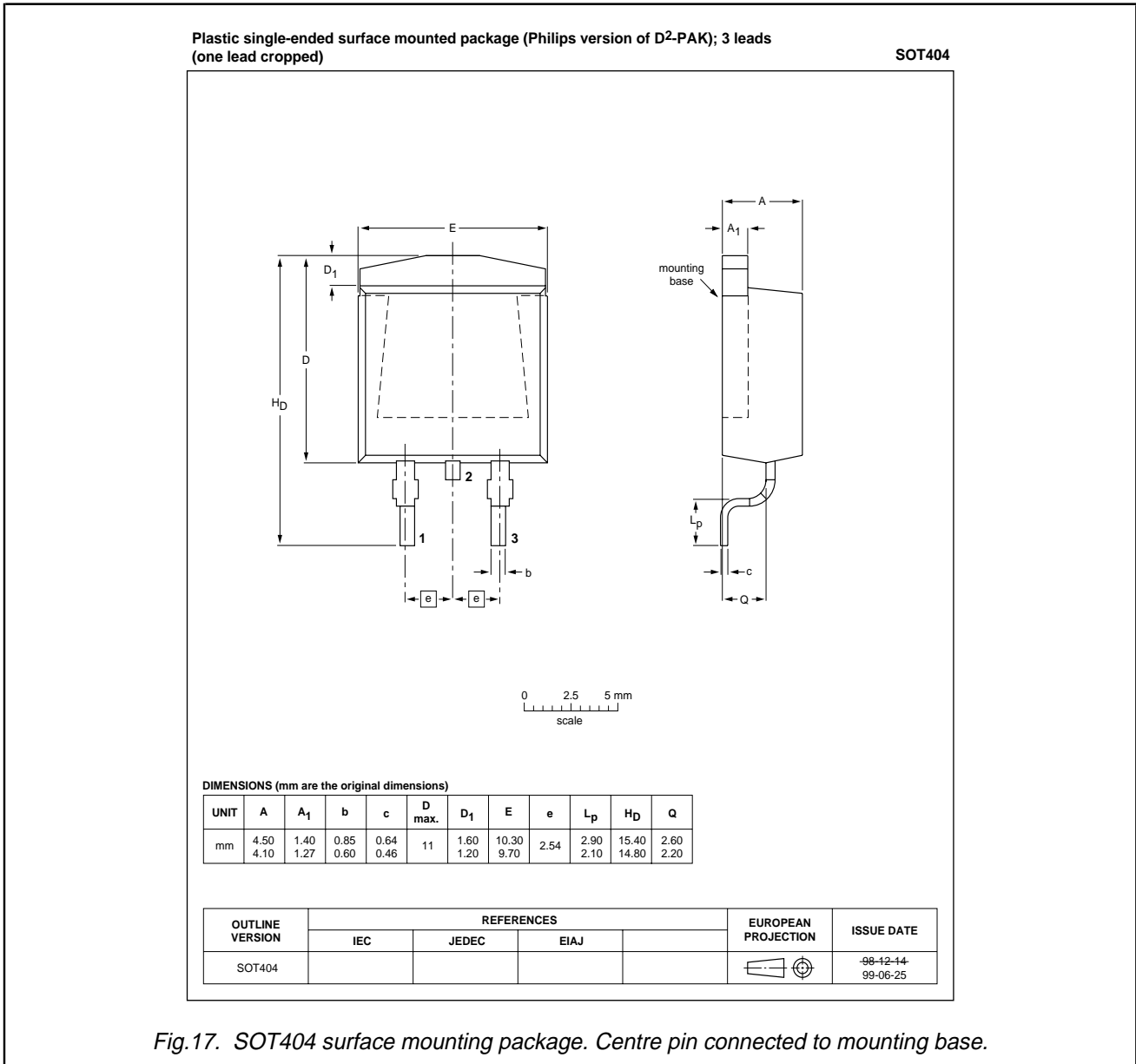
1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to mounting instructions for SOT78 (TO220AB) package.
3. Epoxy meets UL94 V0 at 1/8".

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N-channel logic level TrenchMOS^(TM) transistor

PSMN005-55B;
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MECHANICAL DATA



Notes

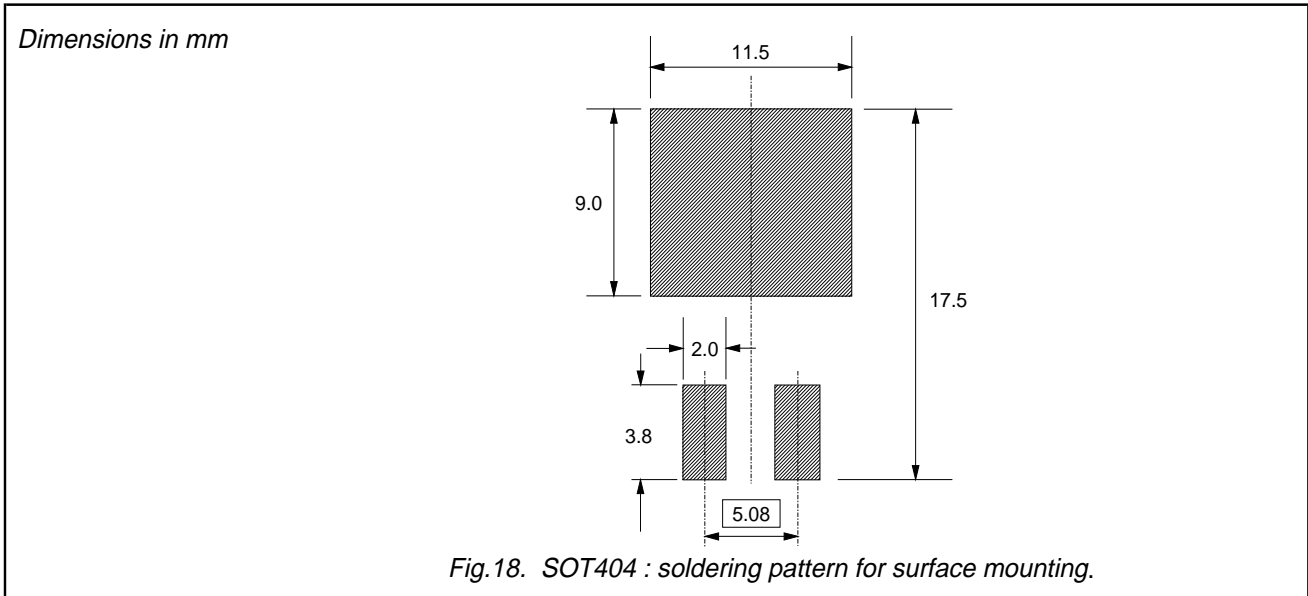
1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
3. Epoxy meets UL94 V0 at 1/8".

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MOUNTING INSTRUCTIONS



DEFINITIONS

| | |
|--|---|
| Data sheet status | |
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Limiting values | |
| Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | |
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N-channel logic level TrenchMOS^(TM) transistor

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NOTES

Philips Semiconductors – a worldwide company

Argentina: see South America

Australia: 3 Figtree Drive, HOME BUSH, NSW 2140,
Tel. +61 2 9704 8141, Fax. +61 2 9704 8139

Austria: Computerstr. 6, A-1101 WIEN, P.O. Box 213,
Tel. +43 1 60 101 1248, Fax. +43 1 60 101 1210

Belarus: Hotel Minsk Business Center, Bld. 3, r. 1211, Volodarski Str. 6,
220050 MINSK, Tel. +375 172 20 0733, Fax. +375 172 20 0773

Belgium: see The Netherlands

Brazil: see South America

Bulgaria: Philips Bulgaria Ltd., Energoproject, 15th floor,
51 James Bourchier Blvd., 1407 SOFIA,
Tel. +359 2 68 9211, Fax. +359 2 68 9102

Canada: PHILIPS SEMICONDUCTORS/COMPONENTS,
Tel. +1 800 234 7381, Fax. +1 800 943 0087

China/Hong Kong: 501 Hong Kong Industrial Technology Centre,
72 Tat Chee Avenue, Kowloon Tong, HONG KONG,
Tel. +852 2319 7888, Fax. +852 2319 7700

Colombia: see South America

Czech Republic: see Austria

Denmark: Sydhavnsgade 23, 1780 COPENHAGEN V,
Tel. +45 33 29 3333, Fax. +45 33 29 3905

Finland: Sinikalliontie 3, FIN-02630 ESPOO,
Tel. +358 9 615 800, Fax. +358 9 6158 0920

France: 51 Rue Carnot, BP317, 92156 SURESNES Cedex,
Tel. +33 1 4099 6161, Fax. +33 1 4099 6427

Germany: Hammerbrookstraße 69, D-20097 HAMBURG,
Tel. +49 40 2353 60, Fax. +49 40 2353 6300

Hungary: see Austria

India: Philips INDIA Ltd, Band Box Building, 2nd floor,
254-D, Dr. Annie Besant Road, Worli, MUMBAI 400 025,
Tel. +91 22 493 8541, Fax. +91 22 493 0966

Indonesia: PT Philips Development Corporation, Semiconductors Division,
Gedung Philips, Jl. Buncit Raya Kav.99-100, JAKARTA 12510,
Tel. +62 21 794 0040 ext. 2501, Fax. +62 21 794 0080

Ireland: Newstead, Clonskeagh, DUBLIN 14,
Tel. +353 1 7640 000, Fax. +353 1 7640 200

Israel: RAPAC Electronics, 7 Kehilat Saloniki St, PO Box 18053,
TEL AVIV 61180, Tel. +972 3 645 0444, Fax. +972 3 649 1007

Italy: PHILIPS SEMICONDUCTORS, Via Casati, 23 - 20052 MONZA (MI),
Tel. +39 039 203 6838, Fax +39 039 203 6800

Japan: Philips Bldg 13-37, Kohnan 2-chome, Minato-ku,
TOKYO 108-8507, Tel. +81 3 3740 5130, Fax. +81 3 3740 5057

Korea: Philips House, 260-199 Itaewon-dong, Yongsan-ku, SEOUL,
Tel. +82 2 709 1412, Fax. +82 2 709 1415

Malaysia: No. 76 Jalan Universiti, 46200 PETALING JAYA, SELANGOR,
Tel. +60 3 750 5214, Fax. +60 3 757 4880

Mexico: 5900 Gateway East, Suite 200, EL PASO, TEXAS 79905,
Tel. +9-5 800 234 7381, Fax +9-5 800 943 0087

Middle East: see Italy

Netherlands: Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB,
Tel. +31 40 27 82785, Fax. +31 40 27 88399

New Zealand: 2 Wagener Place, C.P.O. Box 1041, AUCKLAND,
Tel. +64 9 849 4160, Fax. +64 9 849 7811

Norway: Box 1, Manglerud 0612, OSLO,
Tel. +47 22 74 8000, Fax. +47 22 74 8341

Pakistan: see Singapore

Philippines: Philips Semiconductors Philippines Inc.,
106 Valero St. Salcedo Village, P.O. Box 2108 MCC, MAKATI,
Metro MANILA, Tel. +63 2 816 6380, Fax. +63 2 817 3474

Poland: Al.Jerozolimskie 195 B, 02-222 WARSAW,
Tel. +48 22 5710 000, Fax. +48 22 5710 001

Portugal: see Spain

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Russia: Philips Russia, Ul. Usatcheva 35A, 119048 MOSCOW,
Tel. +7 095 755 6918, Fax. +7 095 755 6919

Singapore: Lorong 1, Toa Payoh, SINGAPORE 319762,
Tel. +65 350 2538, Fax. +65 251 6500

Slovakia: see Austria

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South Africa: S.A. PHILIPS Pty Ltd., 195-215 Main Road Martindale,
2092 JOHANNESBURG, P.O. Box 58088 Newville 2114,
Tel. +27 11 471 5401, Fax. +27 11 471 5398

South America: Al. Vicente Pinzon, 173, 6th floor,
04547-130 SÃO PAULO, SP, Brazil,
Tel. +55 11 821 2333, Fax. +55 11 821 2382

Spain: Balmes 22, 08007 BARCELONA,
Tel. +34 93 301 6312, Fax. +34 93 301 4107

Sweden: Kottbygatan 7, Akalla, S-16485 STOCKHOLM,
Tel. +46 8 5985 2000, Fax. +46 8 5985 2745

Switzerland: Allmendstrasse 140, CH-8027 ZÜRICH,
Tel. +41 1 488 2741 Fax. +41 1 488 3263

Taiwan: Philips Semiconductors, 6F, No. 96, Chien Kuo N. Rd., Sec. 1,
TAIPEI, Taiwan Tel. +886 2 2134 2886, Fax. +886 2 2134 2874

Thailand: PHILIPS ELECTRONICS (THAILAND) Ltd.,
209/2 Sanpavuth-Bangna Road Prakanong, BANGKOK 10260,
Tel. +66 2 745 4090, Fax. +66 2 398 0793

Turkey: Yukari Dudullu, Org. San. Blg., 2.Cad. Nr. 28 81260 Umraniye,
ISTANBUL, Tel. +90 216 522 1500, Fax. +90 216 522 1813

Ukraine: PHILIPS UKRAINE, 4 Patrice Lumumba str., Building B, Floor 7,
252042 KIEV, Tel. +380 44 264 2776, Fax. +380 44 268 0461

United Kingdom: Philips Semiconductors Ltd., 276 Bath Road, Hayes,
MIDDLESEX UB3 5BX, Tel. +44 208 730 5000, Fax. +44 208 754 8421

United States: 811 East Arques Avenue, SUNNYVALE, CA 94088-3409,
Tel. +1 800 234 7381, Fax. +1 800 943 0087

Uruguay: see South America

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